

# RM912

## *CDMA/AMPS 3–4 Volt Power Amplifier (824–849 MHz)*

The RM912 dual mode Code Division Multiple Access (CDMA)/Advanced Mobile Phone Service (AMPS) Power Amplifier is a fully matched 6-pin LCC surface mount module designed for mobile units operating in the 824-849 MHz cellular bandwidth. This device meets stringent IS95 CDMA linearity requirements to beyond 28 dBm output power and can be driven to power output levels beyond 31 dBm for high efficiency FM mode operation. A single GaAs Microwave Monolithic Intergrated Circuit (MMIC) contains all active circuitry in the module. The MMIC contains on-board bias circuitry, as well as input and interstage matching circuits. The output match is realized off-chip within the module package to optimize efficiency and power performance into a 50  $\Omega$  load. This device is manufactured with Conexant's GaAs HBT process that provides for all positive voltage DC supply operation while maintaining high efficiency and good linearity. Primary bias to the RM912 can be supplied directly from a three cell nickel-cadmium, single cell lithium-ion, or other suitable battery with output in the 3-4 volt range. Power down is accomplished by setting the voltage on the low current reference pin to zero volts. No external supply side switch is needed as typical "off" leakage is a few microamperes with full primary voltage supplied from the battery.

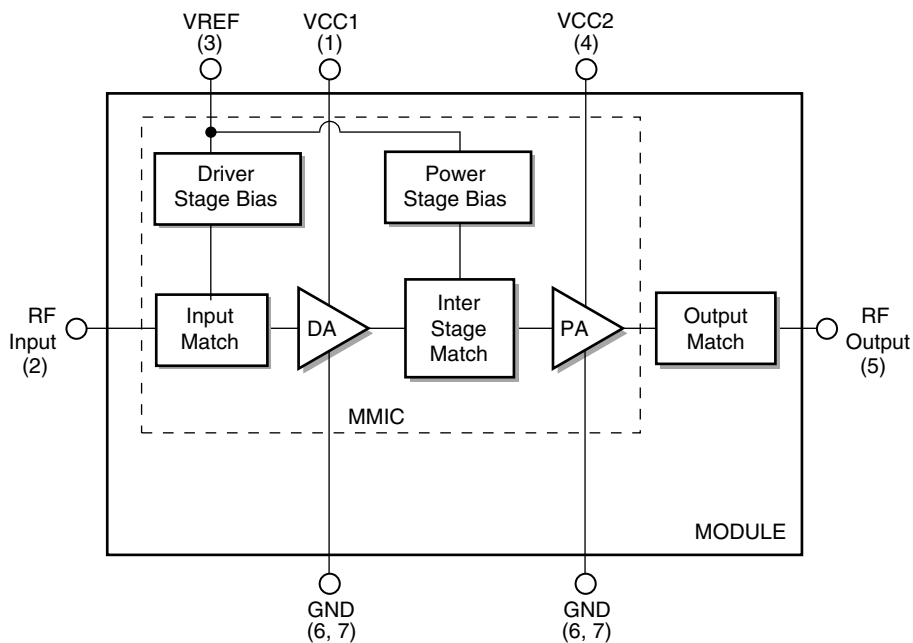
### Distinguishing Features

- Low voltage positive bias supply
- Good linearity
- High efficiency
- Dual mode operation
- Large dynamic range
- 6-pin LCC package (6 x 6 x 1.5 mm)
- Power down control

### Applications

- Digital cellular (CDMA)
- Analog cellular (AMPS)
- Wireless local loop

### Functional Block Diagram



# Electrical Specifications

The following tables list the electrical characteristics of the RM912 Power Amplifier. [Table 1](#) lists the absolute maximum rating for continuous operation. [Table 2](#) lists the recommended operating conditions for achieving the electrical performance listed in [Table 3](#). [Table 3](#) lists the electrical performance of the RM912 Power Amplifier over the recommended operating conditions.

**Table 1. Absolute Maximum Ratings<sup>(1)</sup>**

Parameter	Symbol	Min	Nominal	Max	Unit
RF Input Power	Pin	—	3.0	6.0	dBm
Supply Voltage	Vcc	—	3.4	5.0	Volts
Reference Voltage	Vref	—	3.0	3.3	Volts
Case Operating Temperature	Tc	–30	25	+110	°C
Storage Temperature	Tstg	–55	—	+125	°C
<b>NOTE(S):</b> <sup>(1)</sup> No damage assuming only one parameter is set at limit at a time with all other parameters set at or below nominal value.					

**Table 2. Recommended Operating Conditions**

Parameter	Symbol	Min	Nominal	Max	Unit
Supply Voltage	Vcc	3.2	3.4	4.2	Volts
Reference Voltage	Vref	2.9	3.0	3.1	Volts
Operating Frequency	Fo	824.0	836.5	849.0	MHz
Operating Temperature	To	–30	+25	+85	°C

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**Table 3. Electrical Specifications for CDMA / AMPS Nominal Operating Conditions<sup>(1)</sup>**

Characteristics	Condition	Symbol	Min	Typical	Max	Unit
Quiescent current	Vref = 3.0	I <sub>q</sub>	—	100.0	—	mA
	Vref = 2.9	I <sub>q</sub>	—	80.0	—	mA
Gain–Digital	P <sub>o</sub> = 0 dBm	G	26.0	28.0	—	dB
	P <sub>o</sub> = 28 dBm	G <sub>p</sub>	27.0	29.0	—	dB
Gain–Analog	P <sub>o</sub> = 0 dBm	G	26.0	28.0	—	dB
	P <sub>o</sub> = 31 dBm	G <sub>p</sub>	26.0	28.0	—	dB
Power Added Efficiency						
– Analog Mode	P <sub>o</sub> = 31 dBm	PAE <sub>a</sub>	43.0	45.0	—	%
– Digital Mode	P <sub>o</sub> = 28 dBm	PAE <sub>d</sub>	32.0	34.0	—	%
Adjacent Channel Power <sup>(2)</sup>						
– 885 kHz Offset	P <sub>o</sub> ≤ 28 dBm	ACP1	—	–50.0	–48.0	dBc
–1980 kHz Offset	P <sub>o</sub> ≤ 28 dBm	ACP2	—	–58.0	–56.0	dBc
Harmonic Suppression						
– Second	P <sub>o</sub> ≤ 31 dBm	AFo2	—	–42.0	–30.0	dBc
– Third	P <sub>o</sub> ≤ 31 dBm	AFo3	—	–45.0	–30.0	dBc
Noise Power in RX Band 869–894 MHz	P <sub>o</sub> @ 28 dBm	RxBN	—	–134.0	–133.0	dBm/Hz
Noise Figure	—	NF	—	6.0	—	dB
Input Voltage Standing Wave Ratio	—	VSWR	—	1.4:1	—	—
Stability (Spurious output)	5:1 VSWR All phases	S	—	—	–60.0	dBc
Ruggedness – No damage	P <sub>o</sub> ≤ 31 dBm	Ru	10:1	—	—	VSWR
<b>NOTE(S):</b> <sup>(1)</sup> V <sub>cc</sub> = +3.4 V, V <sub>ref</sub> = +3.0 V, Freq = 836.5 MHz, T <sub>c</sub> = 25 °C, unless otherwise specified. <sup>(2)</sup> ACP is specified per IS95 as the ratio of the total in-band power (1.23 MHz BW) to adjacent power in a 30 kHz BW.						

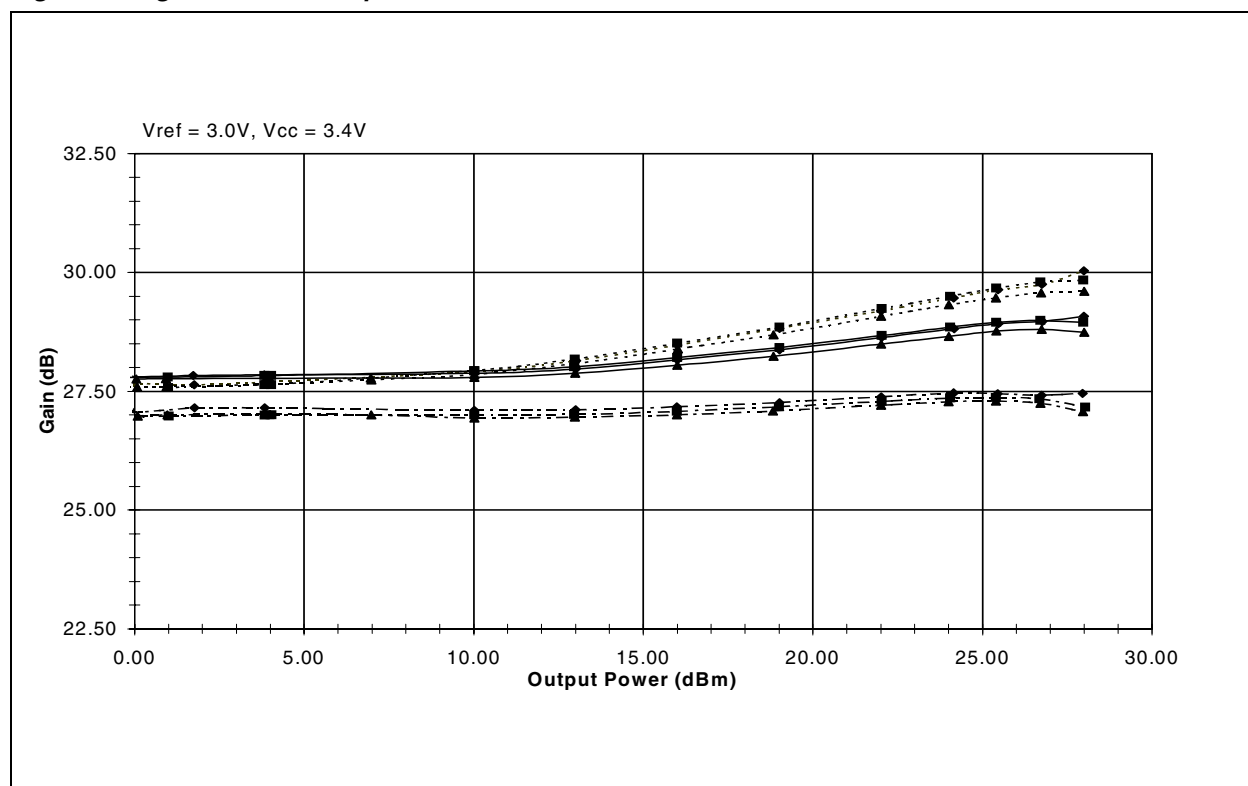
**Table 4. Electrical Specifications Limits for CDMA / AMPS Recommended Operating Conditions<sup>(1)</sup>**

Characteristics	Condition	Symbol	Min	Max	Unit
Quiescent current	Vref = 3.0	I <sub>q</sub>	—	140.0	mA
Gain–Digital	P <sub>o</sub> = 0 dBm	G	25.0	29.0	dB
	P <sub>o</sub> = 28 dBm	G <sub>p</sub>	25.0	32.0	dB
Gain–Analog	P <sub>o</sub> = 0 dBm	G	25.0	29.0	dB
	P <sub>o</sub> = 31dBm	G <sub>p</sub>	24.0	32.0	dB
Power Added Efficiency					
	– Analog Mode	PAE <sub>a</sub>	42.0	—	%
– Digital Mode	P <sub>o</sub> = 28 dBm	PAE <sub>d</sub>	32.0	—	%
Adjacent Channel Power <sup>(2)</sup>					
	– 885 kHz Offset	ACP1	—	–44.0	dBc
–1980 kHz Offset	P <sub>o</sub> ≤ 28 dBm	ACP1	—	–44.0	dBc
	P <sub>o</sub> ≤ 28 dBm	ACP2	—	–56.0	dBc
Harmonic Suppression					
	– Second	AFo2	—	–40.0	dBc
– Third	P <sub>o</sub> ≤ 31 dBm	AFo2	—	–40.0	dBc
	P <sub>o</sub> ≤ 31 dBm	AFo3	—	–40.0	dBc
Noise Power in RX Band 869–894 MHz	P <sub>o</sub> @ 28 dBm	RxBN	—	–131.0	dBm/Hz
Input Voltage Standing Wave Ratio	—	VSWR	—	2:1	—
<b>NOTE(S):</b> <sup>(1)</sup> Per Table 2. <sup>(2)</sup> ACP is specified per IS95 as the ratio of the total in-band power (1.23 MHz BW) to adjacent power in a 30 kHz BW.					

# Characterization Data

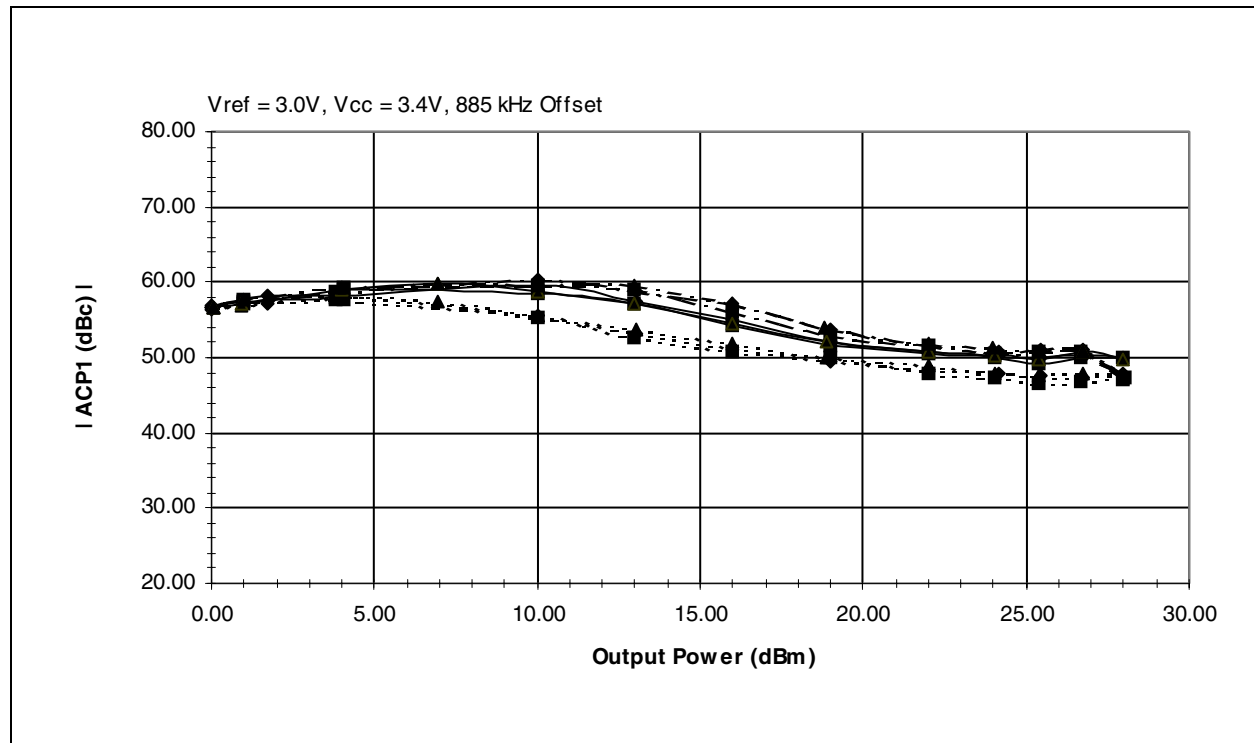
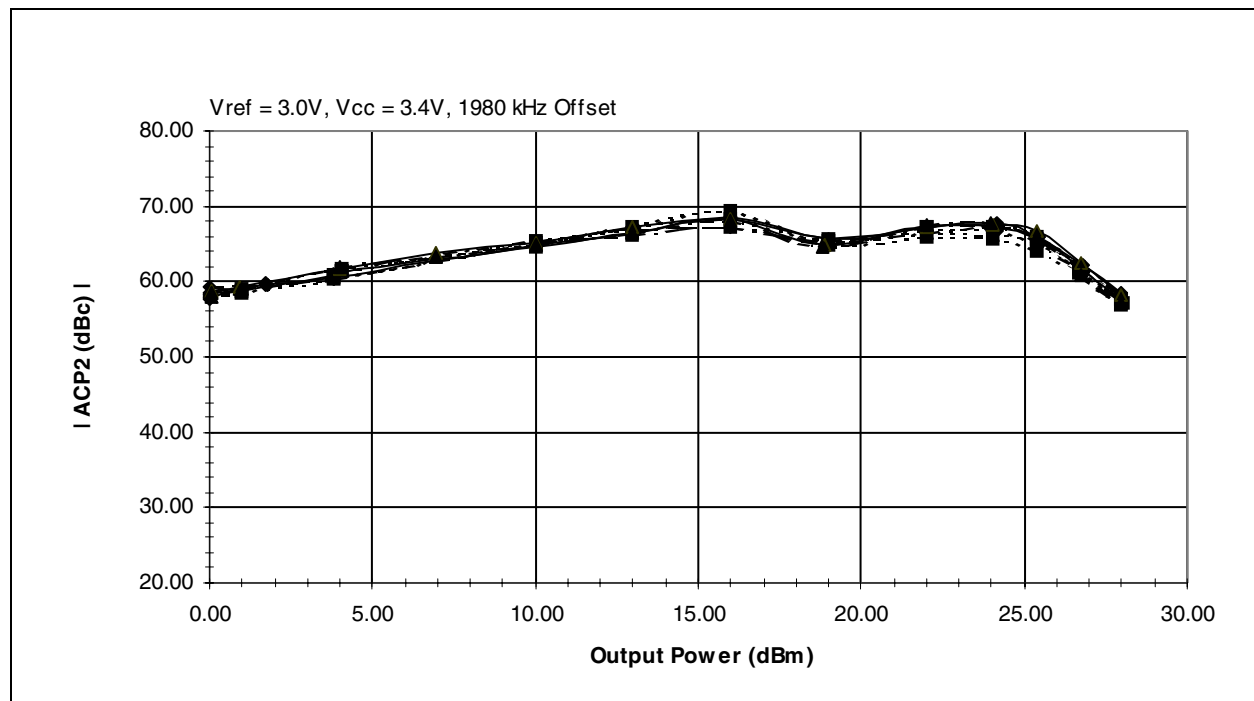
The following charts illustrate the characteristics of a typical RM912 Power Amplifier tested in the evaluation board described in the following section. The amplifier was selected by characterizing a group of devices and choosing a part with average electrical performance at both nominal and worst case (limit) conditions. [Figures 1](#) through [4](#) illustrate the digital signal characteristics and [Figures 5](#) through [8](#) illustrate the analog characteristics of the RM912.

**Figure 1. Digital Gain vs. Output Power**



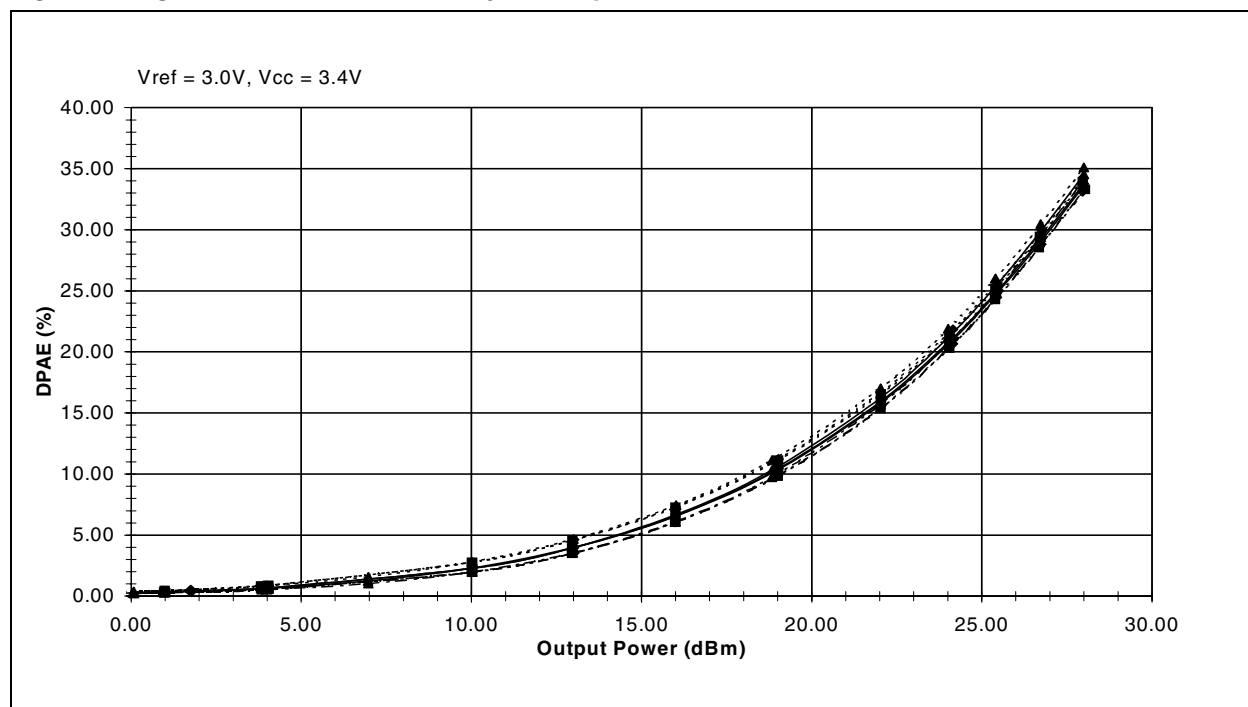
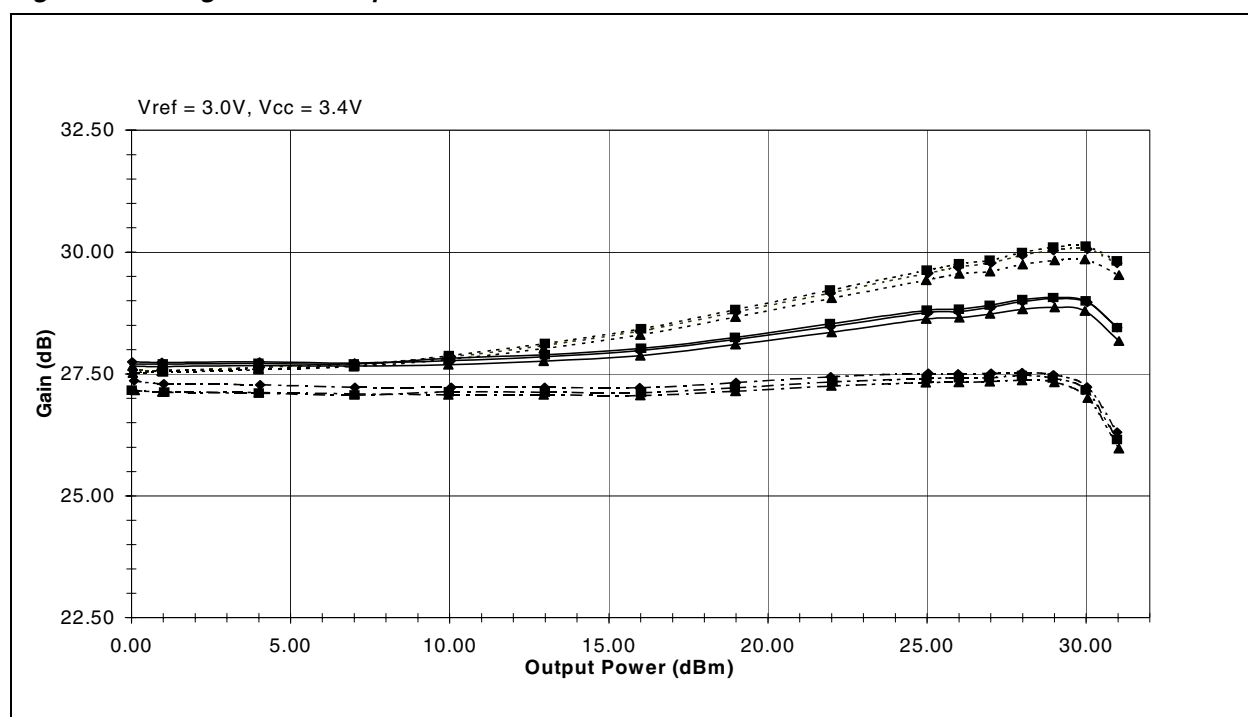
## Legend

---◆---	824 MHz @ -30 °C	—◆—	824 MHz @ +25 °C	---◆--	824 MHz @ +85 °C
---■---	837 MHz @ -30 °C	—■—	837 MHz @ +25 °C	---■--	837 MHz @ +85 °C
---▲---	849 MHz @ -30 °C	—▲—	849 MHz @ +25 °C	---▲--	849 MHz @ +85 °C

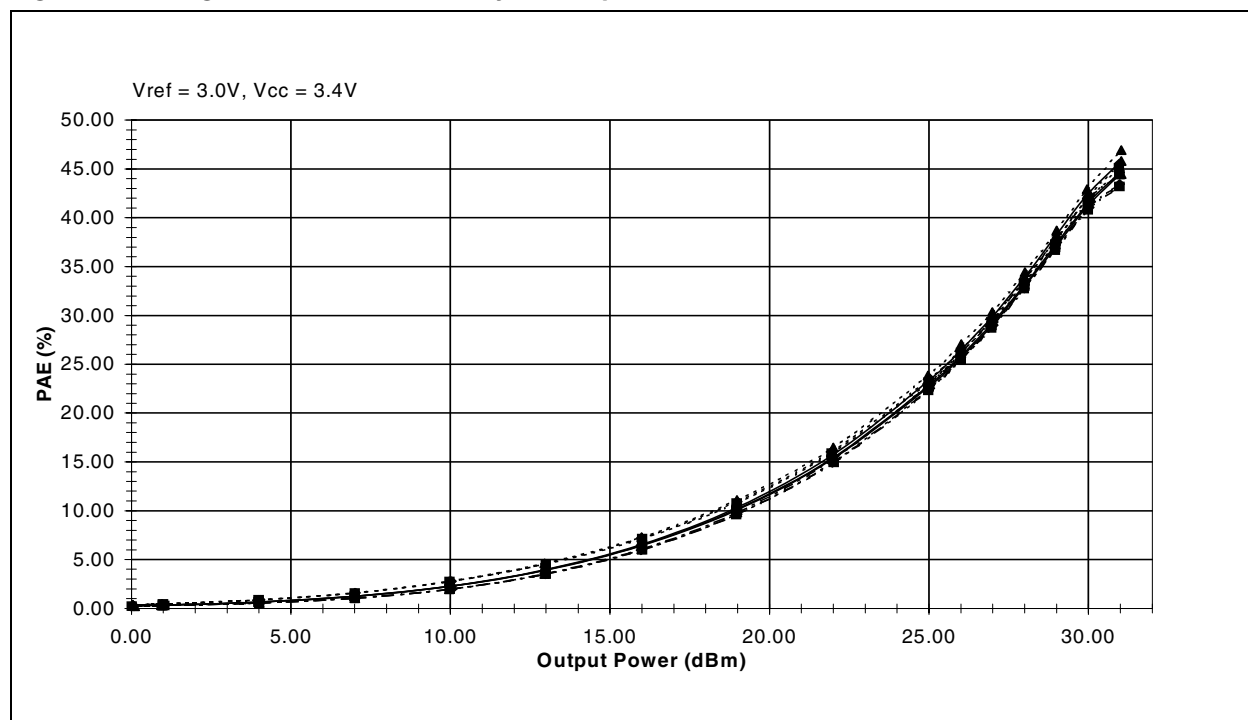
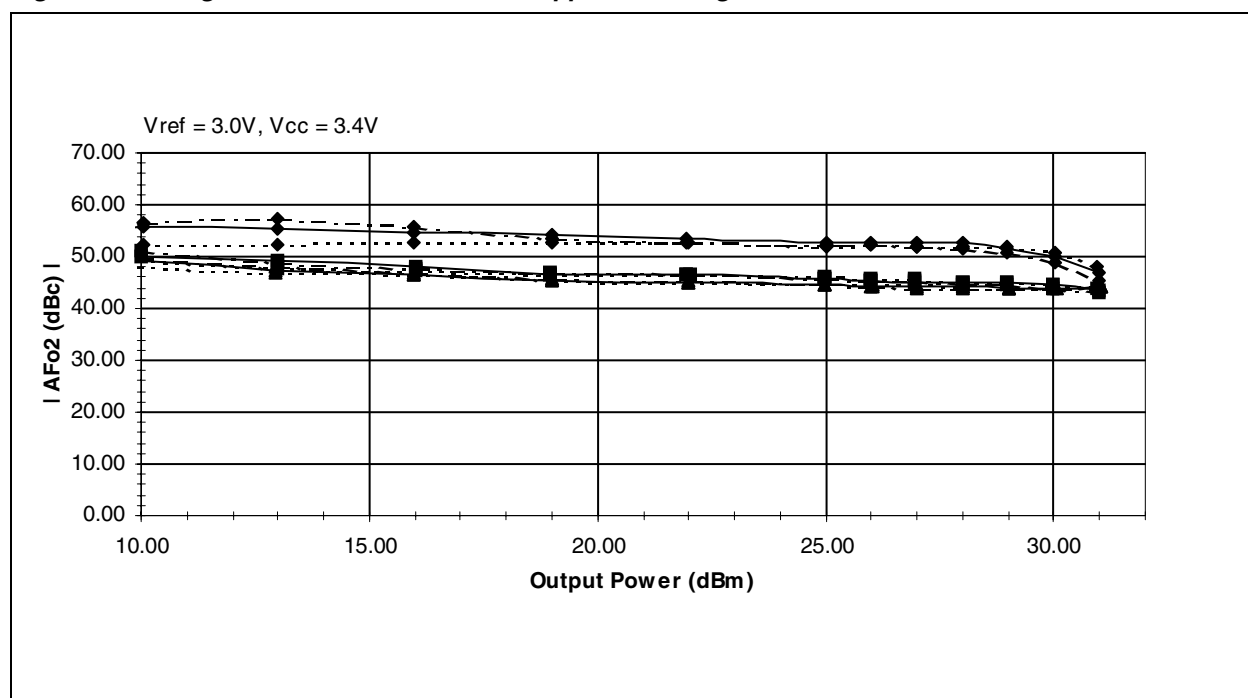
**Figure 2. Digital Adjacent Channel Power Magnitude (ACP1) vs. Output Power****Figure 3. Digital Adjacent Channel Power Magnitude (ACP2) vs. Output Power****Legend**

---◆---	824 MHz @ -30 °C	—◆—	824 MHz @ +25 °C	---◆---	824 MHz @ +85 °C
---■---	837 MHz @ -30 °C	—■—	837 MHz @ +25 °C	---■---	837 MHz @ +85 °C
---▲---	849 MHz @ -30 °C	—▲—	849 MHz @ +25 °C	---▲---	849 MHz @ +85 °C

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**Figure 4. Digital Power Added Efficiency vs. Output Power****Figure 5. Analog Gain vs. Output Power****Legend**

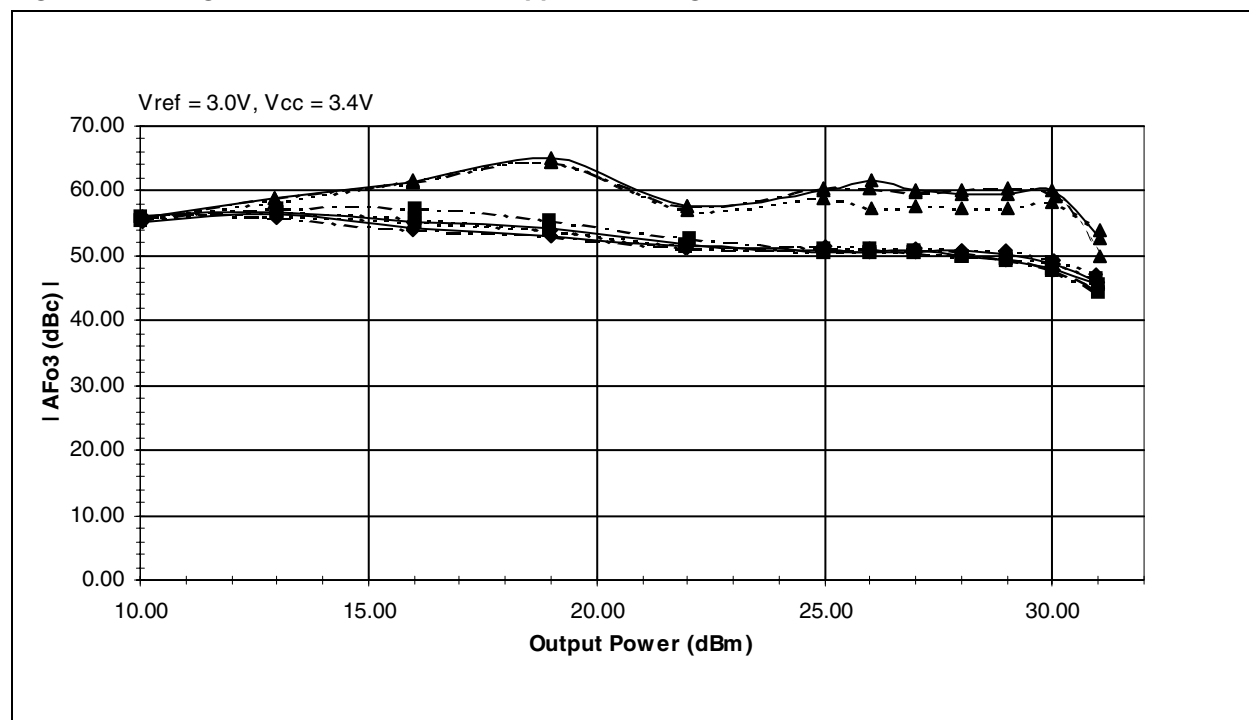
---◆---	824 MHz @ -30 °C	—◆—	824 MHz @ +25 °C	---◆---	824 MHz @ +85 °C
---■---	837 MHz @ -30 °C	—■—	837 MHz @ +25 °C	---■---	837 MHz @ +85 °C
---▲---	849 MHz @ -30 °C	—▲—	849 MHz @ +25 °C	---▲---	849 MHz @ +85 °C

**Figure 6. Analog Power Added Efficiency vs. Output Power****Figure 7. Analog Second Order Harmonic Suppression Magnitude****Legend**

---◆---	824 MHz @ -30 °C	—◆—	824 MHz @ +25 °C	---◆---	824 MHz @ +85 °C
---■---	837 MHz @ -30 °C	—■—	837 MHz @ +25 °C	---■---	837 MHz @ +85 °C
---▲---	849 MHz @ -30 °C	—▲—	849 MHz @ +25 °C	---▲---	849 MHz @ +85 °C

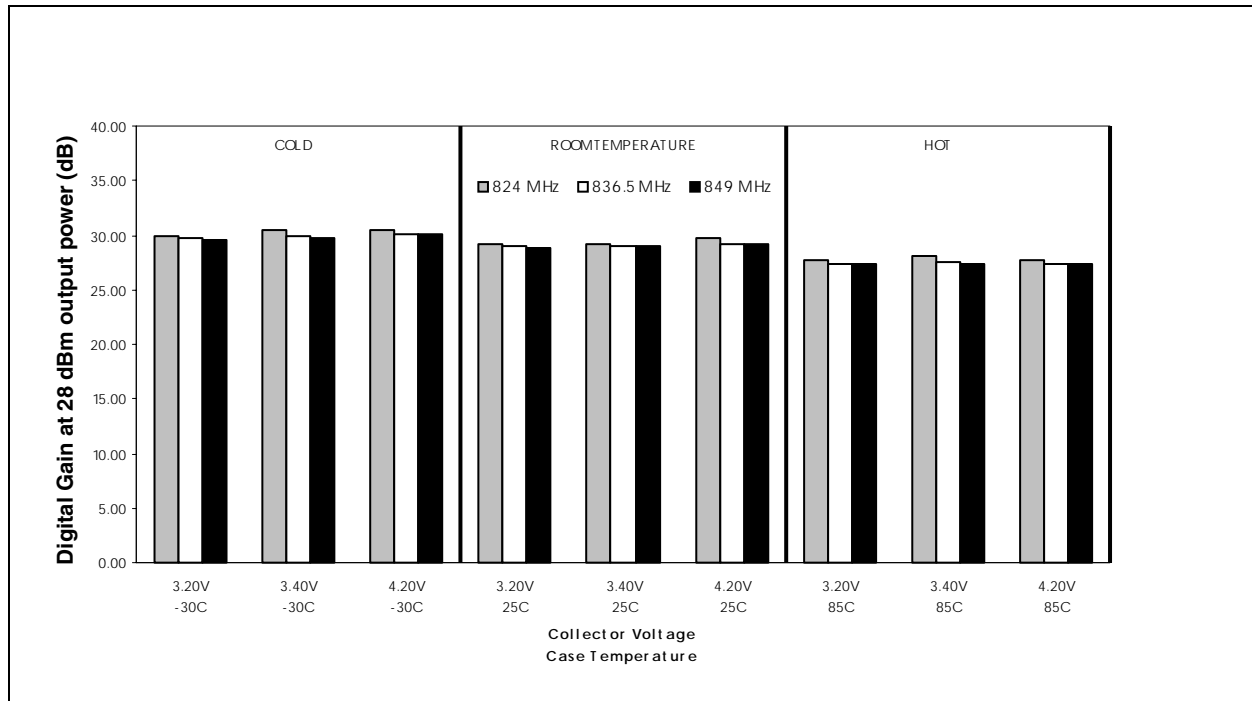
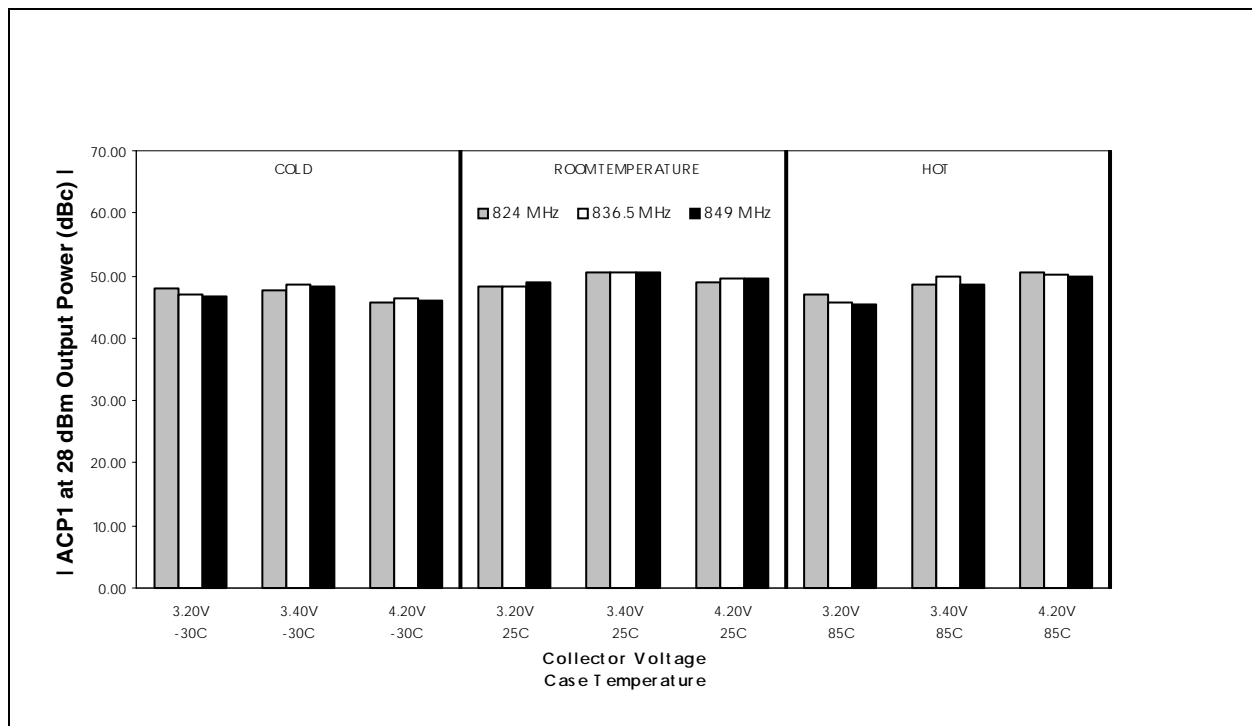


CDMA/AMPS 3–4 Volt Power Amplifier (824–849 MHz)

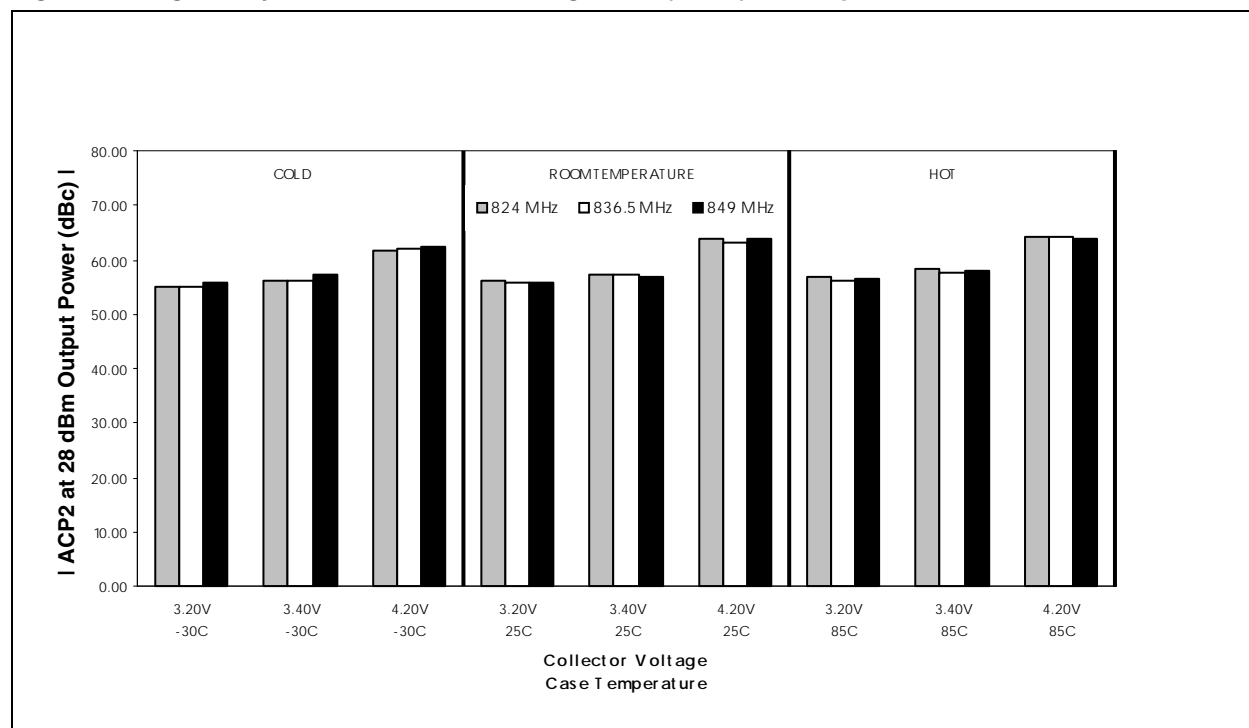
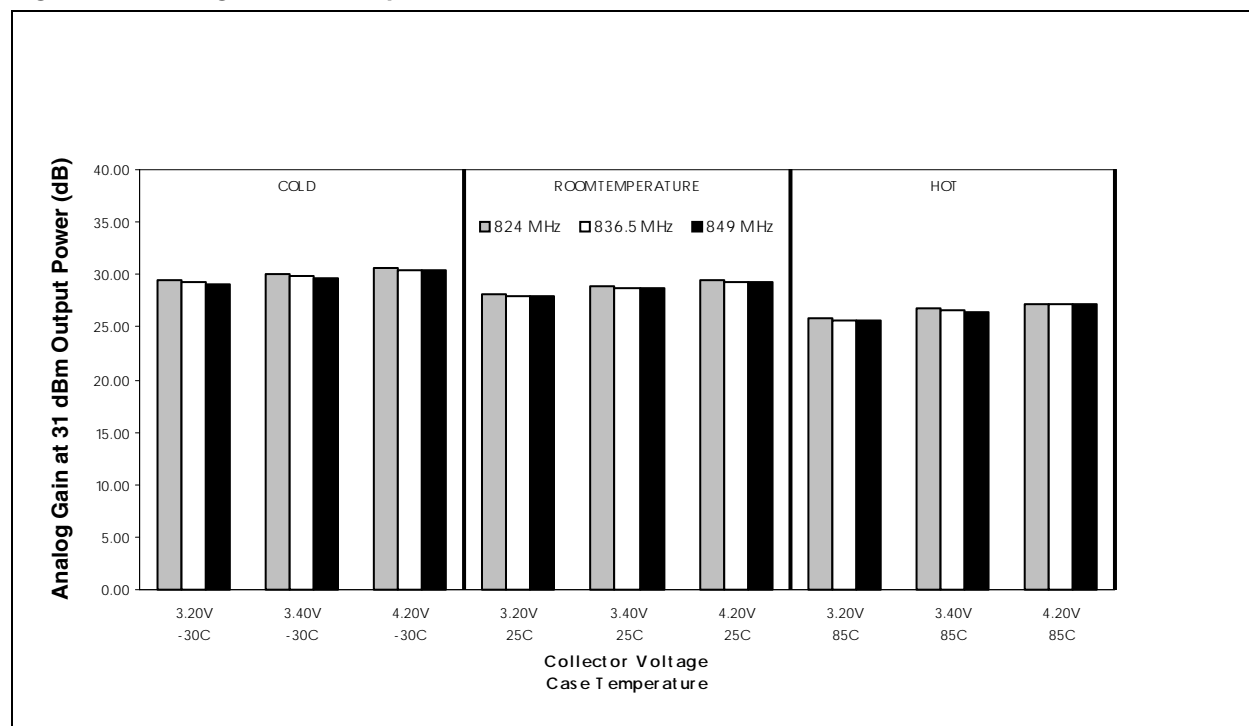
**Figure 8. Analog Third Order Harmonic Suppression Magnitude**

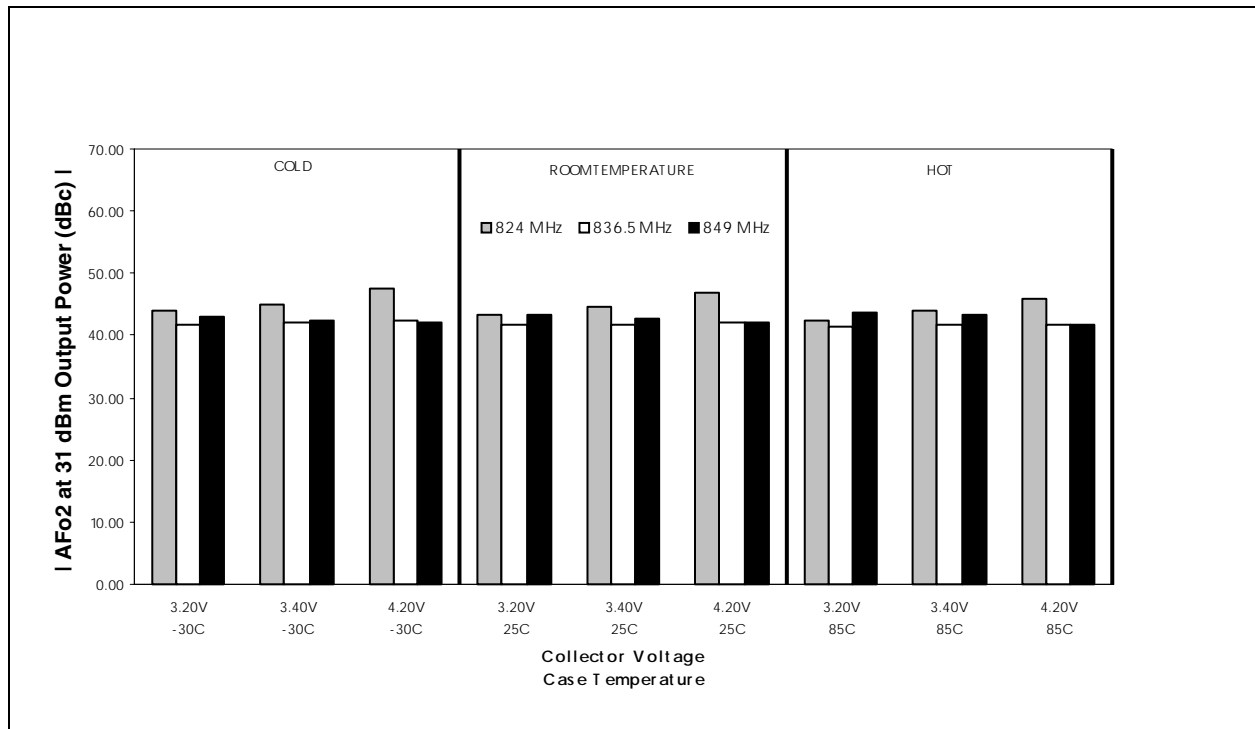
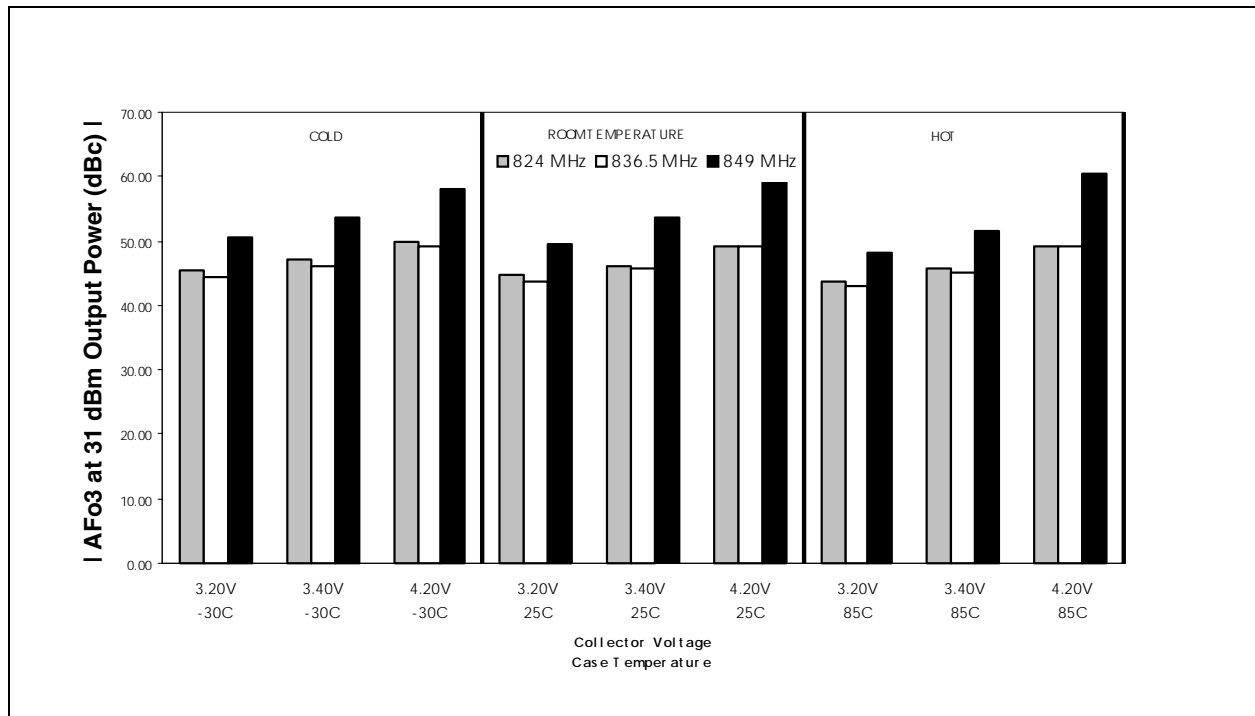
## Legend

---◆---	824 MHz @ -30 °C	—◆—	824 MHz @ +25 °C	---◆---	824 MHz @ +85 °C
---■---	837 MHz @ -30 °C	—■—	837 MHz @ +25 °C	---■---	837 MHz @ +85 °C
---▲---	849 MHz @ -30 °C	—▲—	849 MHz @ +25 °C	---▲---	849 MHz @ +85 °C

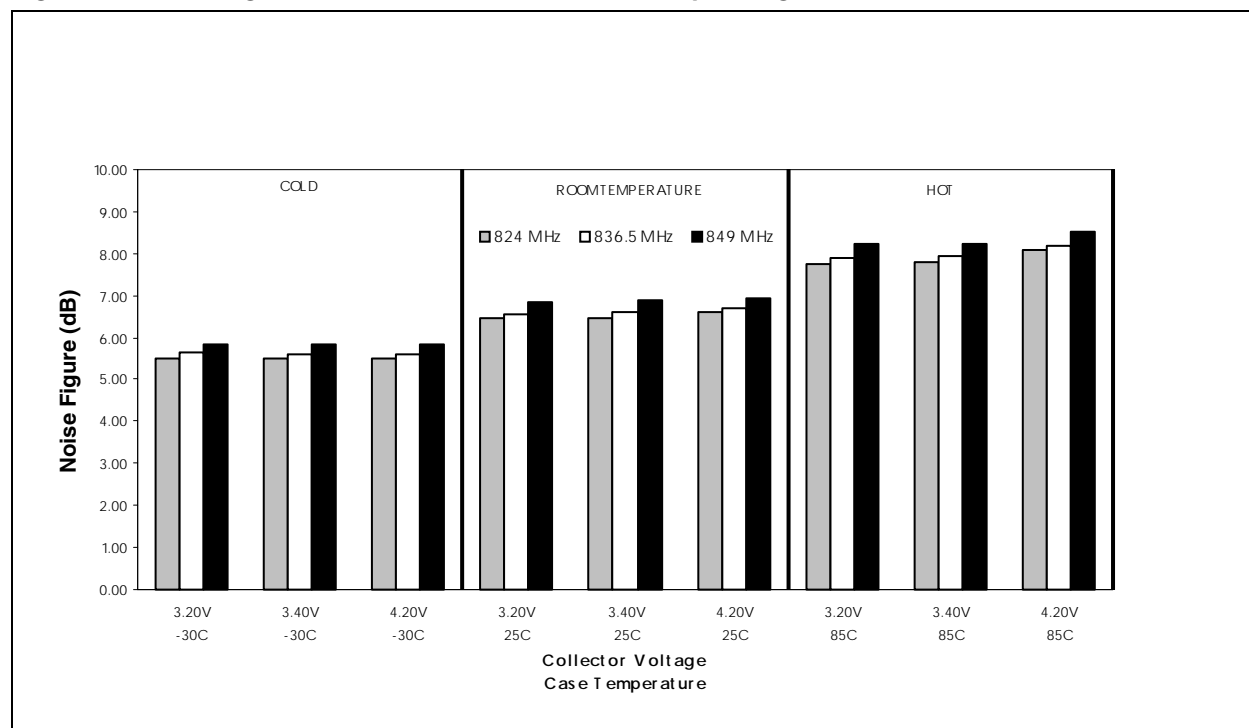
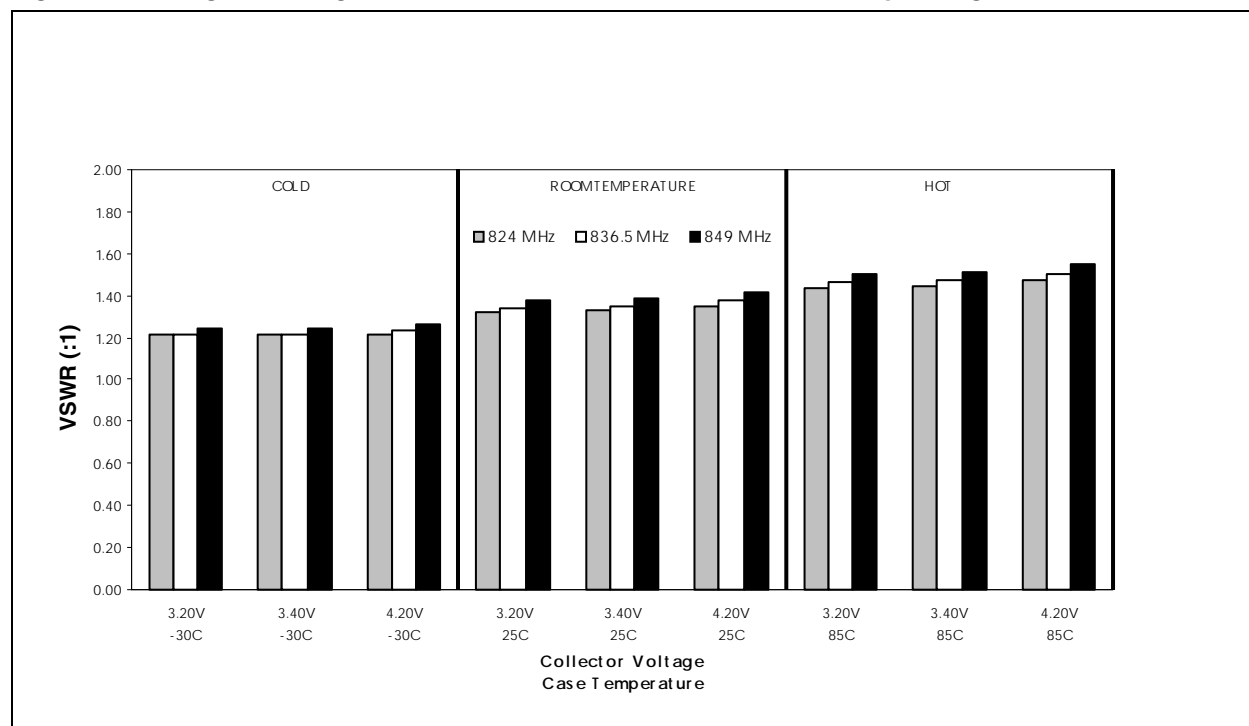
**Figure 9. Digital Gain vs. Output Power****Figure 10. Digital Adjacent Channel Power Magnitude (ACP1) vs. Output Power**

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**Figure 11. Digital Adjacent Channel Power Magnitude (ACP2) vs. Output Power****Figure 12. Analog Gain vs. Output Power**

**Figure 13. Analog Second Order Harmonic Suppression Magnitude****Figure 14. Analog Third Order Harmonic Suppression Magnitude**

## CDMA/AMPS 3–4 Volt Power Amplifier (824–849 MHz)

**Figure 15. Noise Figure Variation Over Recommended Operating Conditions****Figure 16. Voltage Standing Wave Ratio Variation Over Recommended Operating Conditions**

# Evaluation Board Description

The evaluation board is a platform for testing and interfacing design circuitry. To accommodate the interface testing of the RM912, the evaluation board schematic and diagrams are included for preliminary analysis and design. [Figure 17](#) shows the basic schematic of the board for the 824 MHz to 849 MHz range. [Figure 18](#) illustrates the board layout.

Figure 17. Evaluation Board Schematic

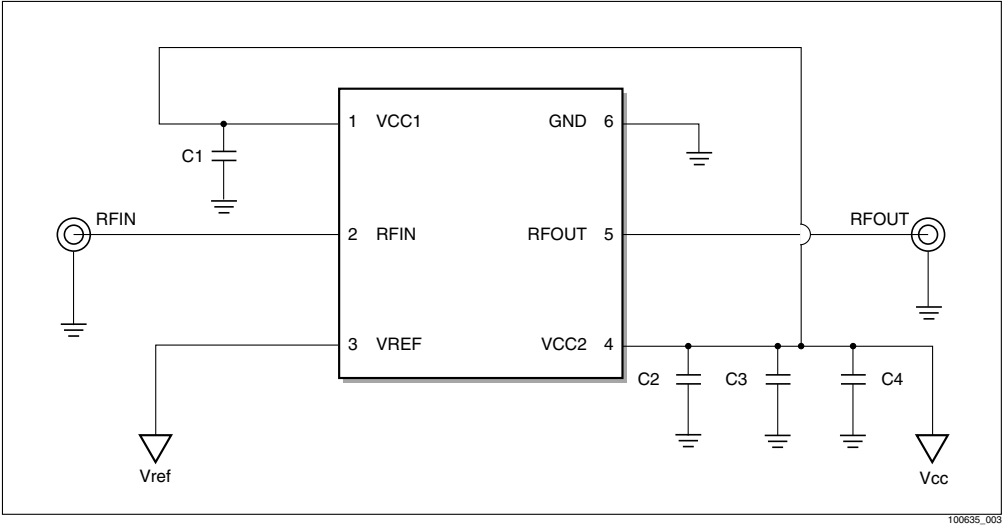
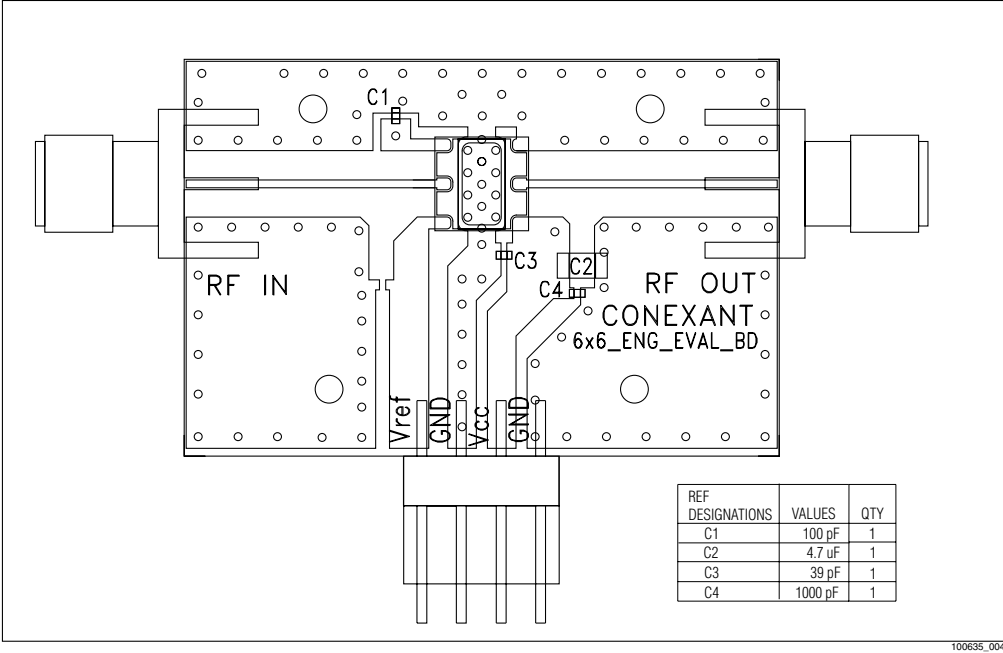


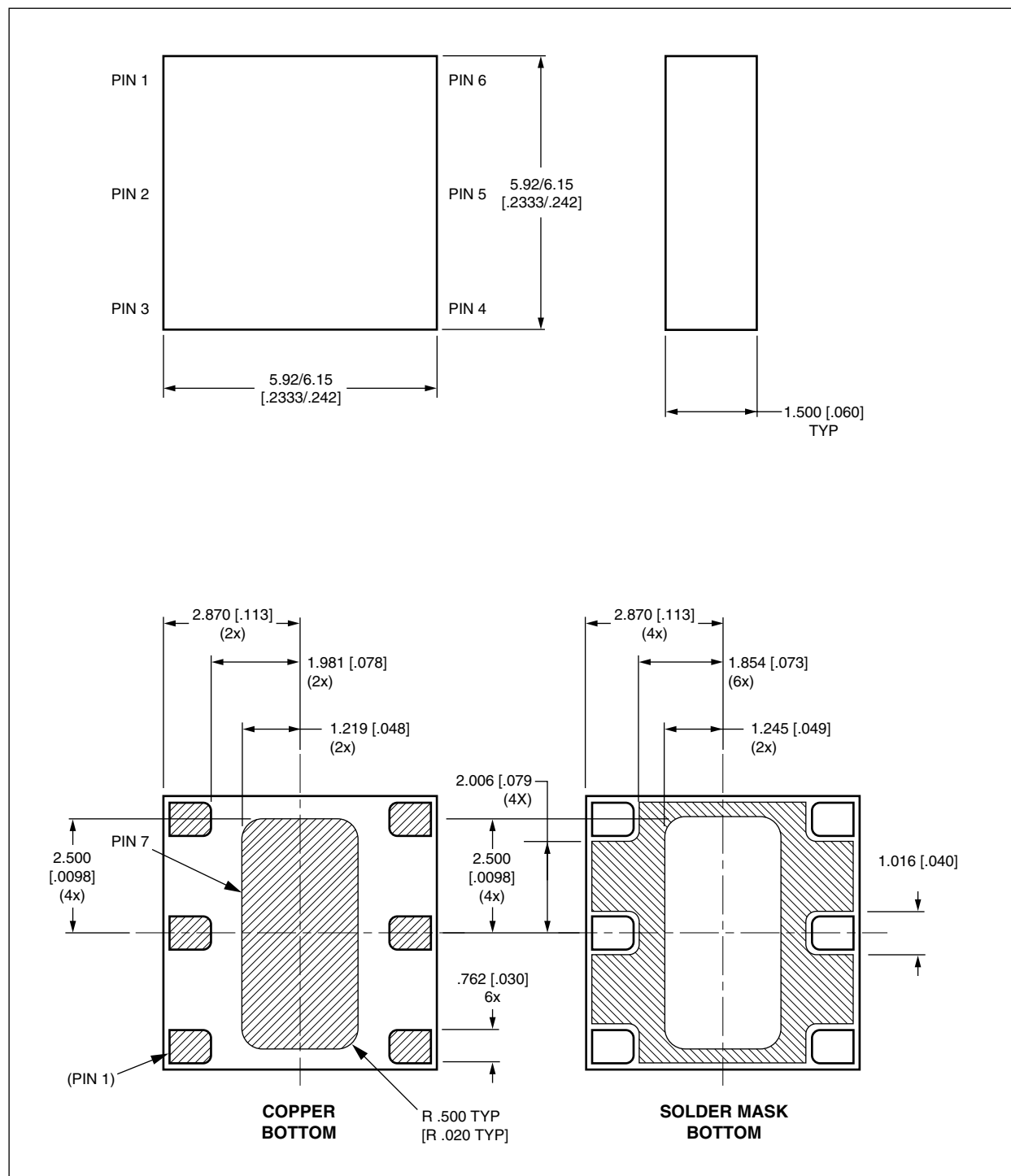
Figure 18. Evaluation Board Assembly Diagram



# Package Dimensions and Pin Descriptions

The RM912 is a multi-layer laminate base, overmold encapsulated modular package designed for surface mount solder attachment to a printed circuit board.

**Figure 19. RM912 Package Drawing**

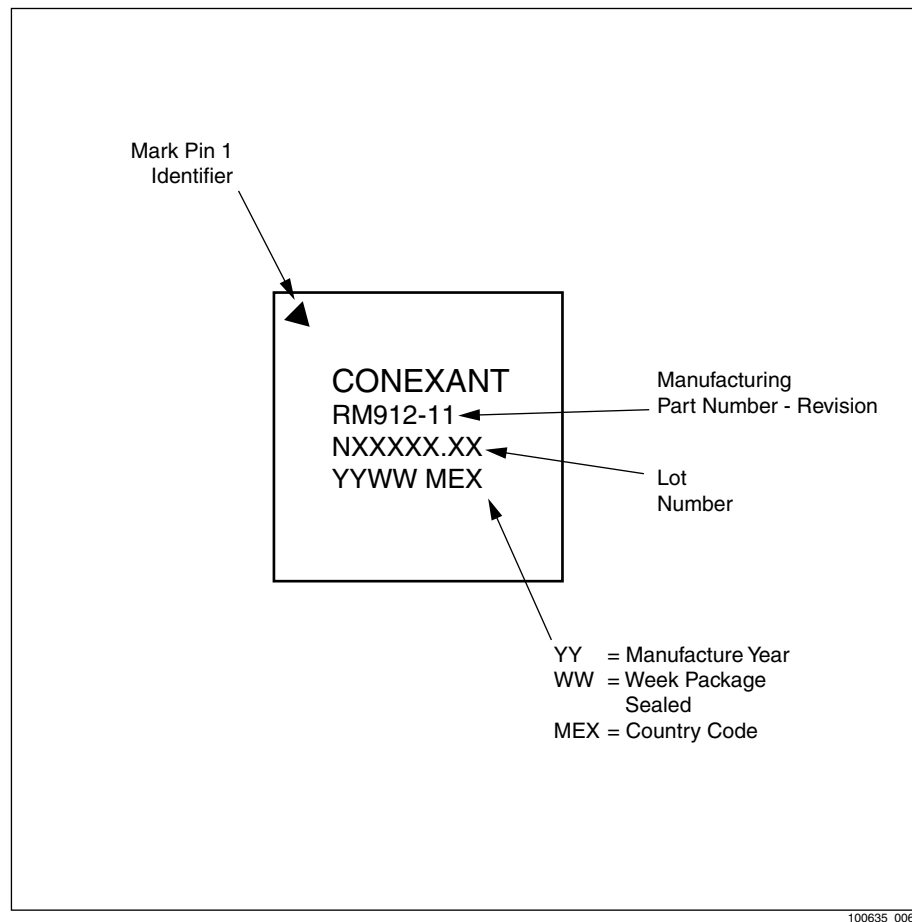


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**Table 5. Pin Description**

Pin #	Function
1	VCC1 <sup>(1)</sup>
2	RF Input
3	VREF
4	VCC2 <sup>(1)</sup>
5	RF Output
6	GND
7	GND <sup>(2)</sup>

**NOTE(S):**  
<sup>(1)</sup> All supply pins may be connected together at the supply.  
<sup>(2)</sup> Package underside is GND.

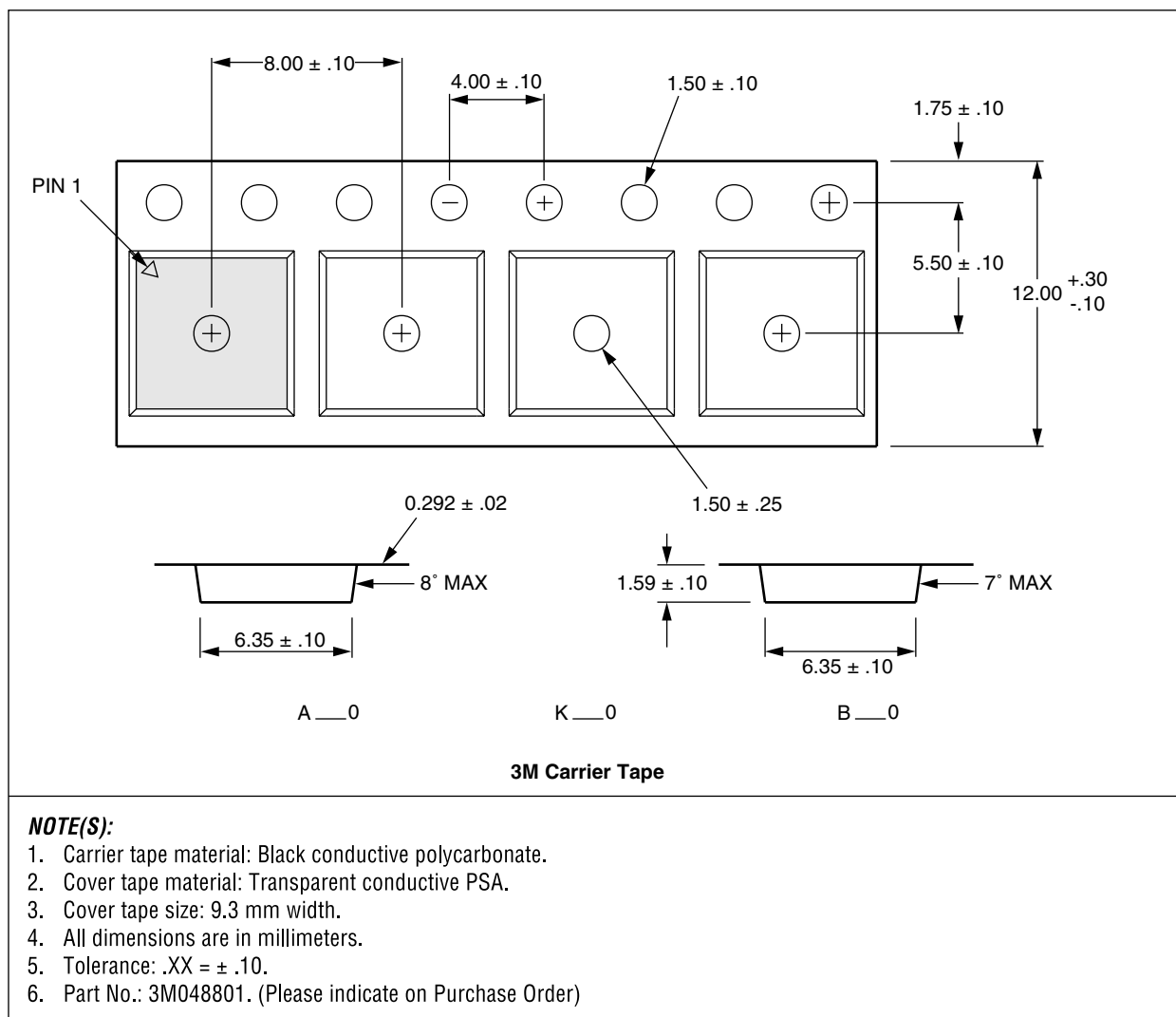
**Figure 20. Typical Case Markings**



## CDMA/AMPS 3–4 Volt Power Amplifier (824–849 MHz)

Production quantities of this product are shipped in the standard tape-and-reel format illustrated below.

**Figure 21. 6 x 6 Tape and Reel**

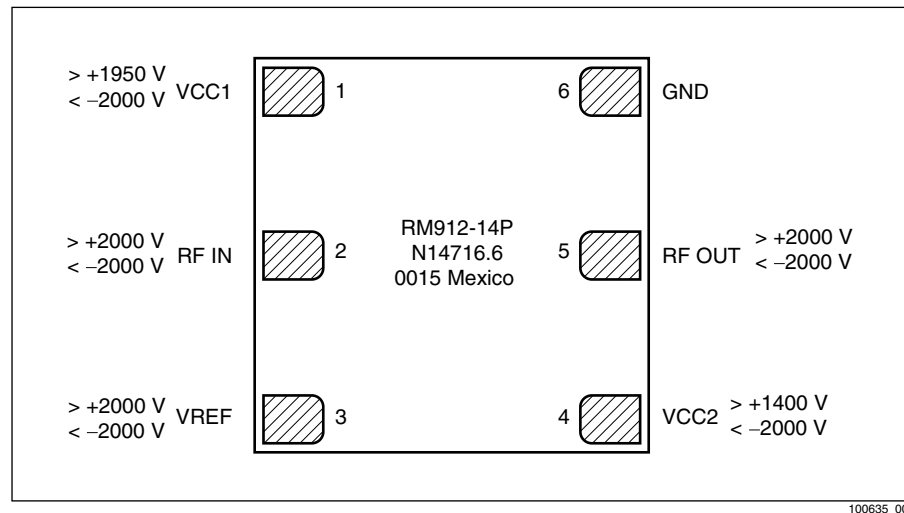


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# Electrostatic Discharge Sensitivity

The RM912 is a Class I device. Figure 22 lists the Electrostatic Discharge (ESD) immunity level for each pin of the RM912 product. The numbers in Figure 22 specify the ESD threshold level for each pin where the I-V curve between the pin and ground starts to show degradation. The ESD testing was performed in compliance with MIL-STD-883E Method 3015.7 using the Human Body Model. Since 2000 volts represents the maximum measurement limit of the test equipment used, pins marked > 2000 V pass 2000V ESD stress.

**Figure 22. ESD Sensitivity Areas**



Various failure criteria can be utilized when performing ESD testing. Many vendors employ relaxed ESD failure standards which fail devices only after “the pin fails the electrical specification limits” or “the pin becomes completely non-functional”. Conexant employs most stringent criteria, fails devices as soon as the pin begins to show any degradation on a curve tracer.

To avoid ESD damage, latent or visible, it is very important the Class-1 ESD handling precautions listed in Table 6 be used in the product assembly and test areas follow.

**Table 6. Precautions for GaAs ICs with ESD Thresholds Greater Than 200V But Less Than 2000V**

<p><b>Personnel Grounding</b></p> <p>Wrist Straps Conductive Smocks, Gloves and Finger Cots Antistatic ID Badges</p>	<p><b>Facility</b></p> <p>Relative Humidity Control and Air Ionizers Dissipative Floors (less than <math>10^9 \Omega</math> to GND)</p>
<p><b>Protective Workstation</b></p> <p>Dissipative Table Tops Protective Test Equipment (Properly Grounded) Grounded Tip Soldering Irons Conductive Solder Suckers Static Sensors</p>	<p><b>Protective Packaging &amp; Transportation</b></p> <p>Bags and Pouches (Faraday Shield) Protective Tote Boxes (Conductive Static Shielding) Protective Trays Grounded Carts Protective Work Order Holders</p>

## Ordering Information

Model Number	Manufacturing Part Number	Product Revision	Package	Operating Temperature
—	RM912	–14	6x6LM–6	–30 °C to +85 °C

## Revision History

Revision	Level	Date	Description
A		March 2000	Preliminary Information
B		March 2000	Updated Preliminary Information
C		June 2000	Added Characterization Data, Released
D		July 2000	Updated ESD Data
E		July 2000	Preprint Update
F		August 2000	Web Site Update
G		August 2000	Web Format Corrections

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